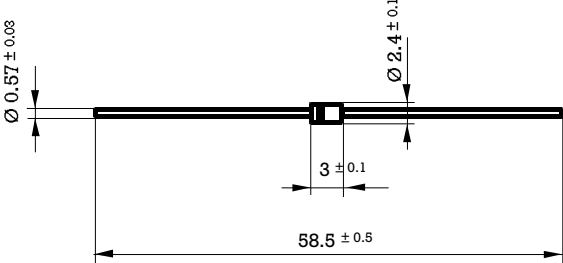



1 Amp. Glass Passivated Junction Rectifier

<p>Dimensions in mm.</p> <p>DO-41-MINI (Plastic)</p>  <p>Mounting instructions</p> <ol style="list-style-type: none"> 1. Min. distance from body to soldering point, 4 mm. 2. Max. solder temperature, 350 °C. 3. Max. soldering time, 3.5 sec. 4. Do not bend lead at a point closer than 2 mm. to the body. 	<p>Voltage 50 to 1000 V.</p> <p>Current 1.0 A. at 25 °C.</p>  <ul style="list-style-type: none"> • Glass passivated junction • High current capability • The plastic material carries U/L recognition 94 V-0 • Terminals: Axial Leads • Polarity: Color band denotes cathode
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Maximum Ratings, according to IEC publication No. 134

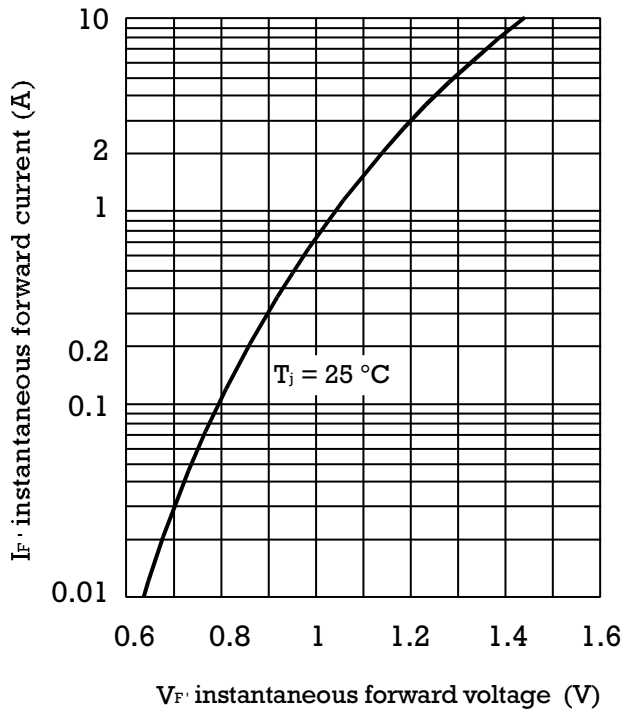
		GP08A	GP08B	GP08D	GP08G	GP08J	GP08K	GP08M
Marking Code		D1	D2	D3	D4	D5	D6	D7
V_{RRM}	Peak recurrent reverse voltage (V)	50	100	200	400	600	800	1000
$I_{F(AV)}$	Forward current at $T_{amb} = 25\text{ °C}$	1.0 A						
I_{FRM}	Recurrent peak forward current	8 A						
I_{FSM}	8.3 ms. peak forward surge current (Jedec Method)	25 A						
T_j	Operating temperature range	– 65 to + 150 °C						
T_{stg}	Storage temperature range	– 65 to + 150 °C						
E_{RSM}	Maximum non repetitive peak reverse avalanche energy. $I_R = 0.5\text{ A}$; $T_j = 25\text{ °C}$	15 mJ						

Electrical Characteristics at $T_{amb} = 25\text{ °C}$

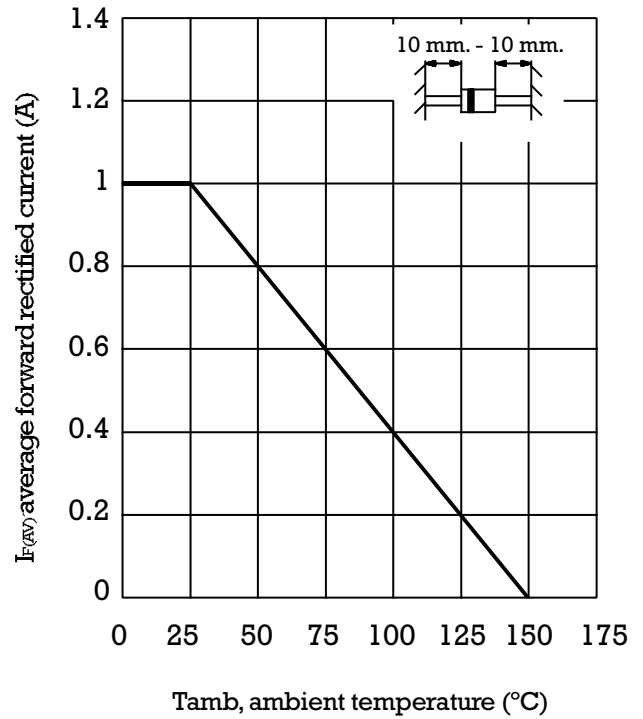
V_F	Max. forward voltage drop at $I_F = 1\text{ A}$	1.1 V
I_R	Max. reverse current at V_{RRM} at 25 °C at 125 °C	5 $\mu\text{ A}$ 50 $\mu\text{ A}$
R_{thj-a} R_{thj-a}	MAXIMUM THERMAL RESISTANCE Junction-Ambient. With Heatsink. Junction-Ambient. In P.C.B.	45 °C/W 100 °C/W

Rating And Characteristic Curves

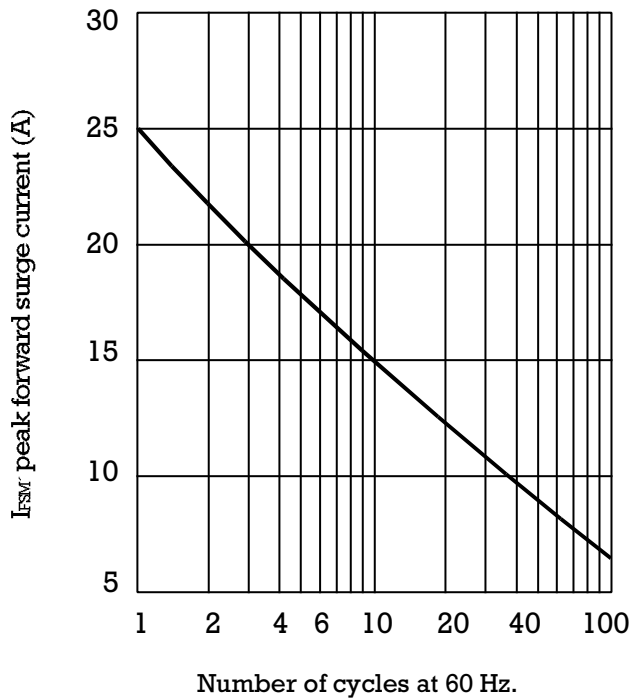
TYPICAL FORWARD CHARACTERISTIC



FORWARD CURRENT DERATING CURVE



MAXIMUM NON REPETITIVE
PEAK FORWARD SURGE CURRENT



TYPICAL JUNCTION CAPACITANCE

